

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	61311	(solder near mask)and (polypropylene near glycol near tetra near acrylate)with (meth near acrylic near acid) acrylate with monomer and initiator	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 14:51
L2	2	(solder near mask)and (polypropylene near glycol near tetra near acrylate)with (meth near acrylic near acid) and acrylate with monomer and initiator	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 14:51
L3	1	(solder and resist)and (polypropylene near glycol near tetra near acrylate)with (meth near acrylic near acid) and acrylate with monomer and initiator	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 14:52
L4	2	solder and (polypropylene near glycol near tetra near acrylate)with(meth near acrylic near acid)and acrylate with monomer and initiator	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 14:52
L5	1	resist and UV and (polypropylene near glycol near tetra near acrylate)with (meth near acrylic near acid) and acrylate with monomer and initiator	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 14:52
L6	1	resist and UV and (polypropylene near glycol near tetra near acrylate)same (meth near acrylic near acid) and acrylate with monomer and initiator	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 14:52
L7	2	(polypropylene near glycol near tetra near acrylate)same (meth near acrylic near acid) and acrylate with monomer and initiator	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 14:55
L8	2	(((((polypropylene)or(poly near propylene)) near glycol) or polypropyleneglycol) near tetra near acrylate)same (meth near acrylic near acid)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 14:58

L9	2	((((polypropylene)or(poly near propylene)) near glycol) or polypropyleneglycol) near tetra near acrylate)and(meth near acrylic near acid)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 14:59
L10	5	((((polypropylene)or(poly near propylene)) near glycol) or polypropyleneglycol) near tetra near acrylate)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 14:59
L11	991	((((polypropylene)or(poly near propylene)) near glycol) or polypropyleneglycol) with (tetraacrylate or(tetra near acrylate)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:00
L12	65	((((polypropylene)or(poly near propylene)) near glycol) or polypropyleneglycol) near4 (tetraacrylate or(tetra near acrylate)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:00
L13	34	((((polypropylene)or(poly near propylene)) near glycol) or polypropyleneglycol) near2 (tetraacrylate or(tetra near acrylate)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:00
L14	17	((((polypropylene)or(poly near propylene)) near glycol) or polypropyleneglycol) near2 (tetraacrylate or(tetra near acrylate)))and solder	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:00
L15	5	"5264324"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:05
L16	19	((((polypropylene)or(poly near propylene)) near3 glycol)or polypropyleneglycol) near2 (tetraacrylate or(tetra near acrylate)))and solder	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:08
L18	0	solder near mask and (acrylated near epoxy near monomer)with molecular near weight	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:26

L19	0	solder and (acrylat\$ near epoxy near monomer)with molecular near weight	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:26
L20	91	solder and (acrylat\$4 near epoxy near monomer)with molecular near weight	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:26
L21	0	solder and (acrylat\$4 near epoxy near monomer)with molecular near weight	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:26
L22	0	resist and (acrylat\$4 near epoxy near monomer)with molecular near weight	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:27
L23	4	resist and (acrylat\$4 near epoxy near monomer)same molecular near weight	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:27
L24	0	solder and (acrylat\$4 near epoxy near monomer)same molecular near weight	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:28
L25	14	solder and (acrylat\$4 near epoxy near monomer)and molecular near weight	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 15:29
L26	140	solder and (acrylat\$4 near epoxy with monomer)and molecular near weight	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 16:16
L27	22	solder and (acrylat\$4 near epoxy) with monomer with molecular near weight	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 16:17

S1	1	10/528583	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/06 18:14
S2	584	solder and actinic and acrylate and initiator and polymer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/06 18:16
S3	451	solder and actinic and acrylate and initiator and polymer and adhesion	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/06 18:16
S4	191	solder and actinic and acrylate and initiator and polymer and adhesion near promot\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/06 18:16
S5	99	solder and actinic and acrylate and initiator and polymer and adhesion near promot\$4 and surfactant	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/06 18:19
S6	12	solder and actinic and acrylate and initiator and polymer and adhesion near promot\$4 and surfactant and koh	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/06 18:21
S7	12	solder and actinic and acrylate and initiator and polymer and adhesion near promot\$4 and surfactant and koh and acid	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/06 18:21
S8	12	solder near mask and actinic and acrylate and initiator and polymer and adhesion near promot\$4 and surfactant and koh and acid	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/09 14:48
S9	12	solder near mask and actinic and acrylate and initiator and polymer and adhesion near promot\$4 and surfactant and koh and acid	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/09 14:48

S10	1	10/528583	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/09 14:51
S11	11	"5721007"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/09 15:22
S12	83	"5270368"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/09 15:49
S13	22	"4270985"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/09 15:57
S14	270	(UV or actinic) and acrylate and initiator and polymer and adhesion near promot\$4 and surfactant and koh and acid near carboxylic	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 12:56
S15	211	(UV or actinic) and acrylate and initiator and polymer and adhesion near promot\$4 and surfactant and koh and acid near carboxylic and poly	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 12:56
S16	270	(UV or actinic) and acrylate and initiator and polymer and adhesion near promot\$4 and surfactant and koh and acid near carboxylic and polymer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 12:56
S17	5460757	(UV or actinic) and acrylate and initiator and polymer and adhesion near promot\$4 and surfactant and koh and acid near carboxylic and polymer circuit\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 12:57
S18	59	(UV or actinic) and acrylate and initiator and polymer and adhesion near promot\$4 and surfactant and koh and acid near carboxylic and polymer and circuit\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 12:57

S19	73	(UV or actinic) and acrylate and initiator and polymer and ((adhesion near promot \$4)withacid near carboxylic) and surfactant and koh and polymer and circuit\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 13:01
S20	6	(UV or actinic) and acrylate and initiator and polymer and ((adhesion near promot \$4)with(acid near carboxylic)) and surfactant and koh and polymer and circuit\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 13:04
S21	86513	alan.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 13:05
S22	2472	hopper.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 13:05
S23	34	S21 and S22	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 13:05
S24	2	"20050171237"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 13:13
S25	18	(UV or actinic) and acrylate and initiator and polymer and ((adhesion near promot \$4)with(acid near carboxylic)) and polymer and circuit\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 13:27
S26	6	(UV or actinic) and acrylate and initiator and polymer and ((adhesion near promot \$4)with(acid near carboxylic)) and polymer and circuit\$4 and ((isobornyl near acrylate) or(tripropylene near glycol near diacrylate) or (trimethylolpropane near ethoxylate near triacrylate))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 13:36

S27	6	(UV or actinic) and acrylate and initiator and polymer and ((adhesion near promot \$4)with(acid near carboxylic)) and polymer and circuit\$4 and ((isobornyl near acrylate) or(tripropylene near glycol near diacrylate) or (trimethylolpropane near ethoxylate near triacrylate))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 13:36
S28	17	"5089376"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 13:45
S29	17	"5089376"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 17:02
S30	4	S29 and solder and UV	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 17:02
S31	2	viscosity with("40" near degree)and solder near mask	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/10 18:05
S32	4	"5217847"	USPAT	OR	OFF	2009/02/11 11:57
S33	26	(solder near mask)and(acid near value) and koh	USPAT	OR	OFF	2009/02/11 12:09
S34	59	(solder near mask)and(acid near value) and koh	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 12:09
S35	56	(solder near mask)and(acid near value) with koh	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 12:09

S36	0	(solder near mask)and(acid near value) with koh and acrylat	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 12:09
S37	52	(solder near mask)and(acid near value) with koh and acrylate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 12:09
S38	44	(solder near mask)and(acid near value) with koh and acrylate and initiator	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 12:09
S39	8	(solder near mask)and(acid near value) with koh and acrylate and initiator and ink near jet	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 12:10
S40	2	"20030134926"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 12:16
S41	44	(solder near mask)and(acid near value) with koh and acrylate and initiator	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 12:17
S42	32	(solder near mask)and(acid near value) with koh and acrylate with monomer and initiator	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/02/11 12:18

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